

LCWS 2018

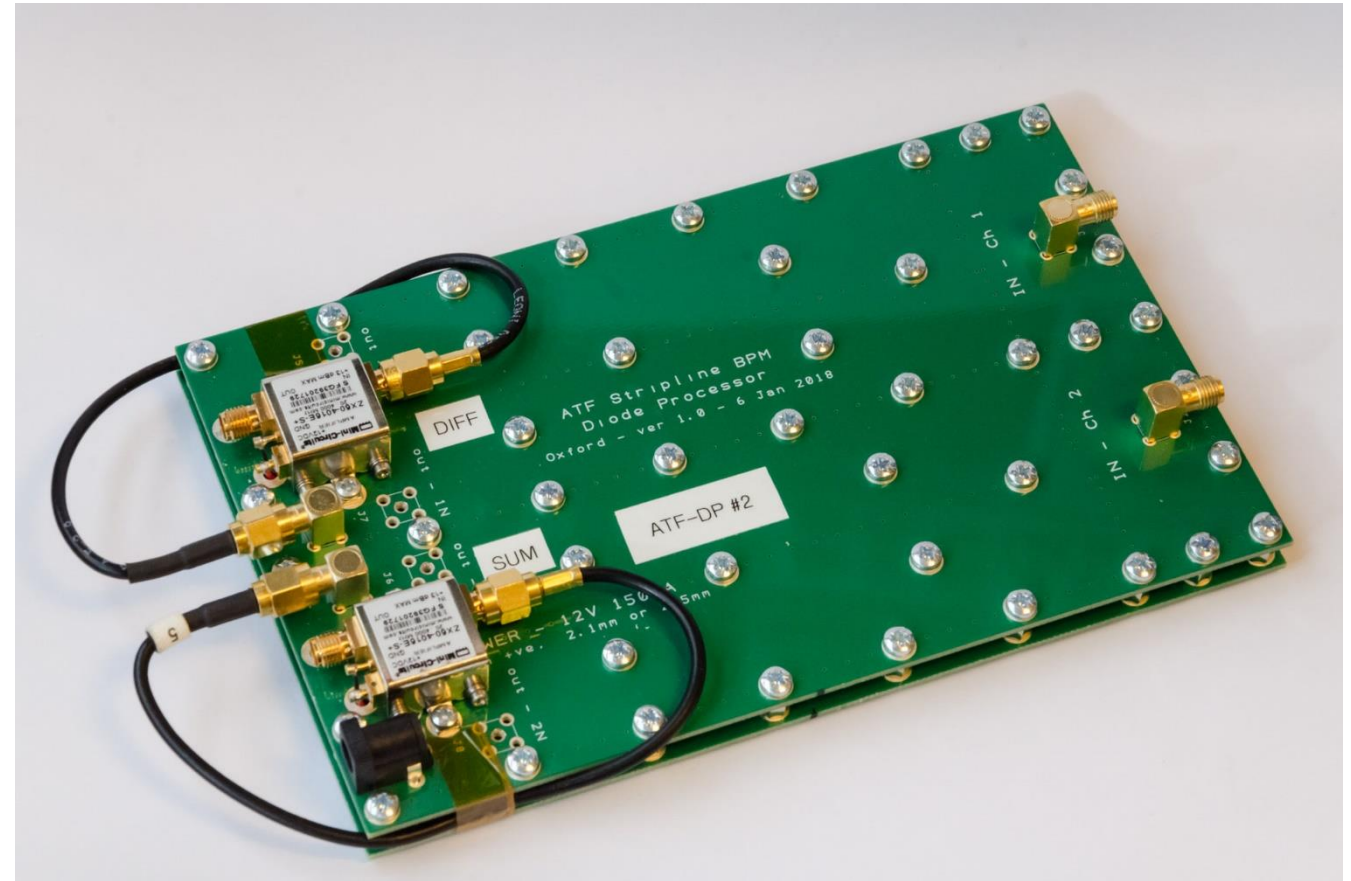
Wednesday 24th October 2018

**Design and test of a very
low-latency BPM signal
processor for use in the
CLIC IP FB system**

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Contents

- Background
- Processor design
- Results from ATF



Background: Motivation

- The Compact Linear Collider (CLIC) will require a beam position feedback system at the interaction point (IP)
- This will require a beam position monitor (BPM) with the following characteristics:
 - Low latency
 - Simple, reliable
 - Rad-hard, tolerant of high magnetic field (no ferrites!)
 - Resolution not critical
- These requirements are met by a stripline BPM used with the simplest possible processor: a diode detector on each strip
- ...but would resolution of such a processor be adequate?

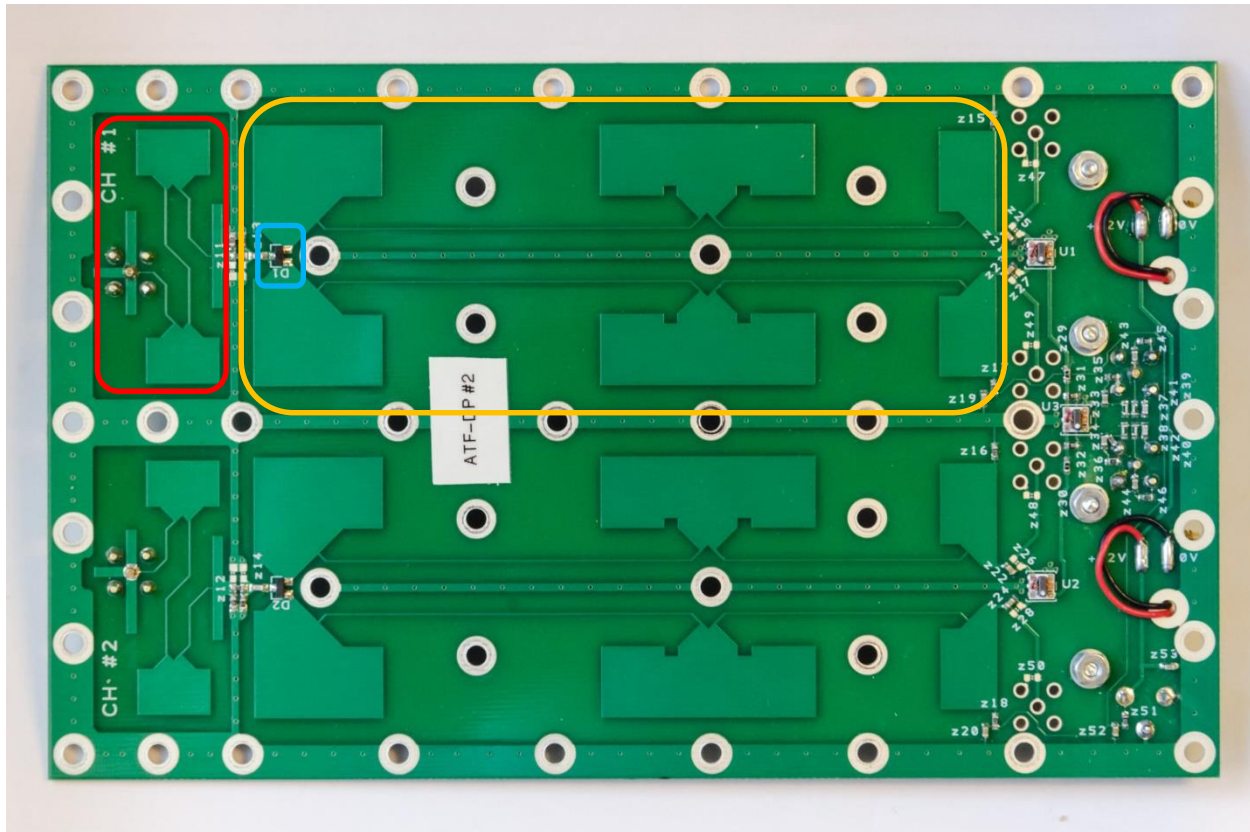
Background: Design

- A prototype was constructed for testing at the KEK Accelerator Test Facility (ATF)
 - Harder: single bunch beam rather than a train (comparable bunch charge)
 - Easier: BPM output peaks around 700 MHz versus 2 GHz bunch frequency for CLIC
- Processor designed to scale up in frequency
 - Filters would scale down in size by a factor ~ 2 , using 0.8 mm RF substrate instead of 1.6 mm FR4*
 - Replace silicon Schottky diodes in large packages (SOT23) with GaAs diodes in smaller packages
- At CLIC processor outputs would be input to differential amplifiers on custom GaAs MMIC**
 - FONT5 digitizer at ATF unable to handle pulses this narrow due to 357 MHz ADCs, so supplement diode processor with an additional stage to condition signals

*FR4: glass-reinforced epoxy laminate material

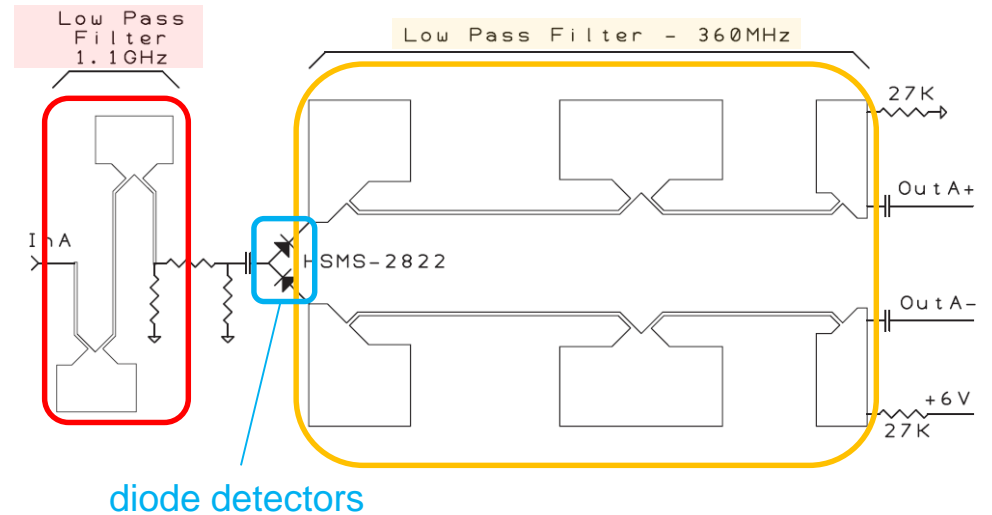
**MMIC: Monolithic Microwave Integrated Circuit

Diode processor: Schematic



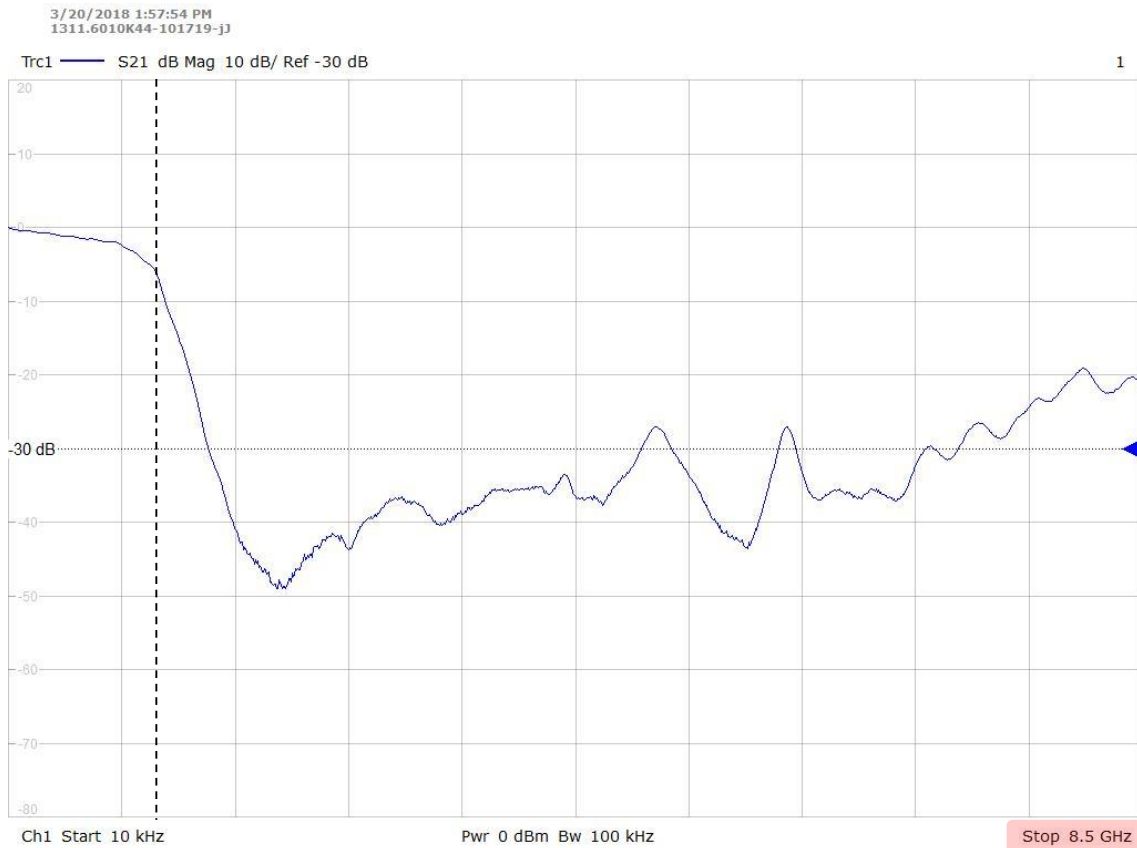
- First microstrip LPF (1.1 GHz)
- Diode detectors
- Second microstrip LPF (360 MHz)

CHANNEL A - Channel B is similar

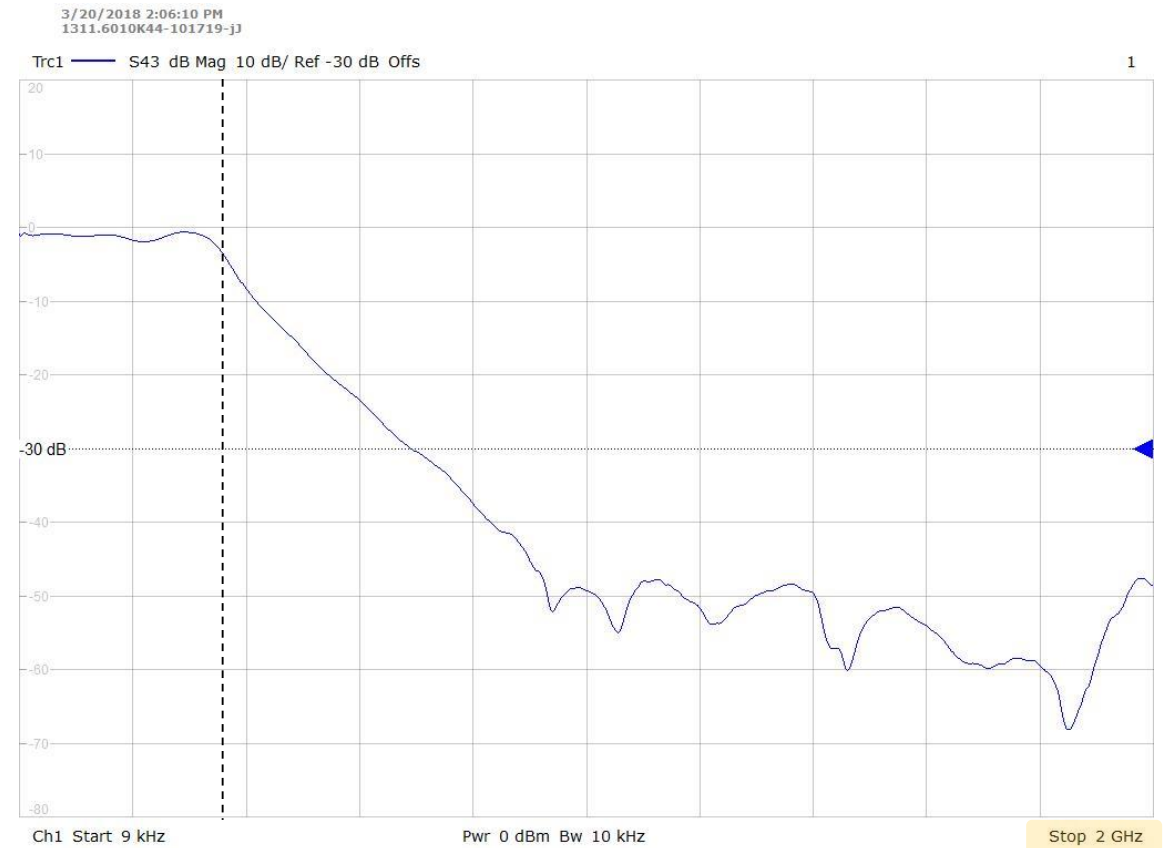


Diode processor: Filtering

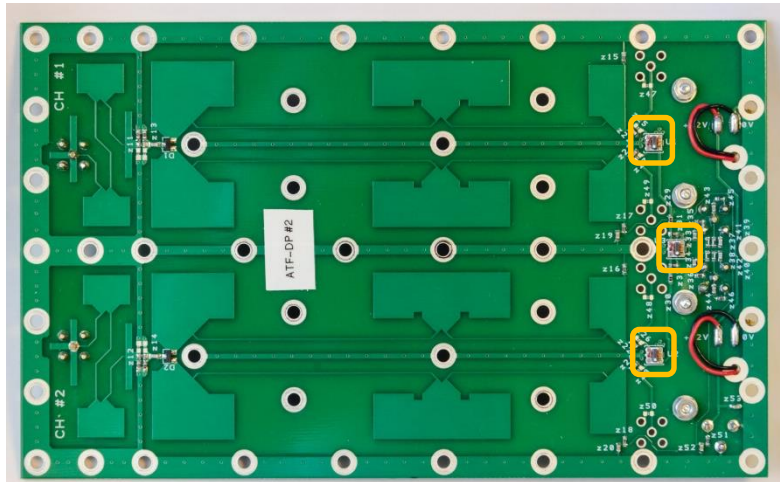
First filter: 1.1 GHz low-pass



Second filter: 360 MHz low-pass

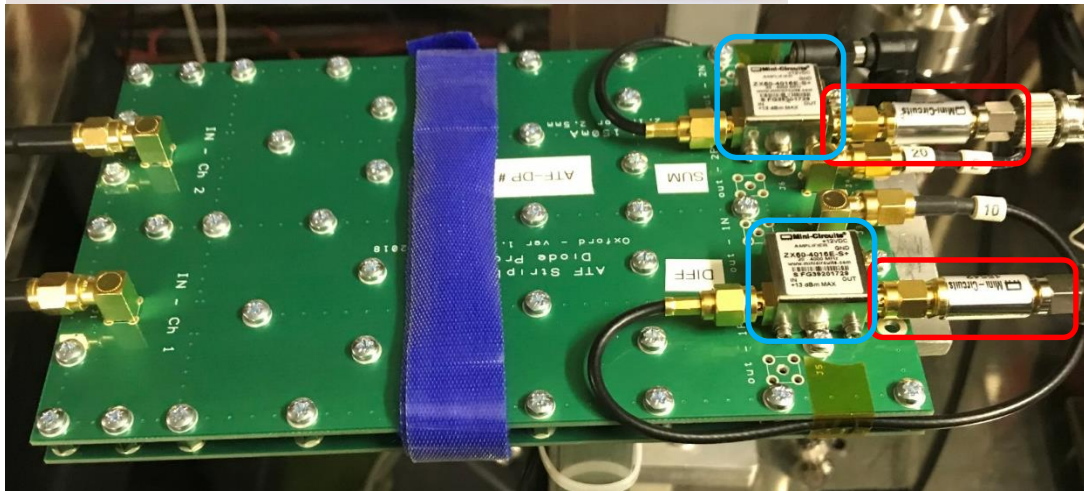


Supplemental stage: Schematic

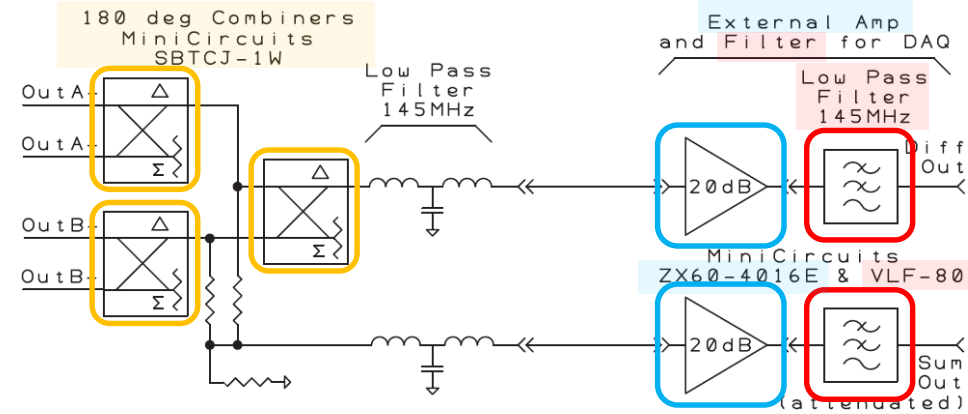


- 180° combiners to form the difference of the two inputs
- Narrow LPF (145 MHz) to broaden the pulse
- External amplifier to suit digitizer sensitivity
- External LPF (145 MHz) to reduce amplifier noise

Reduced bandwidth widens output pulse but should not otherwise improve performance (for single bunch case at ATF)



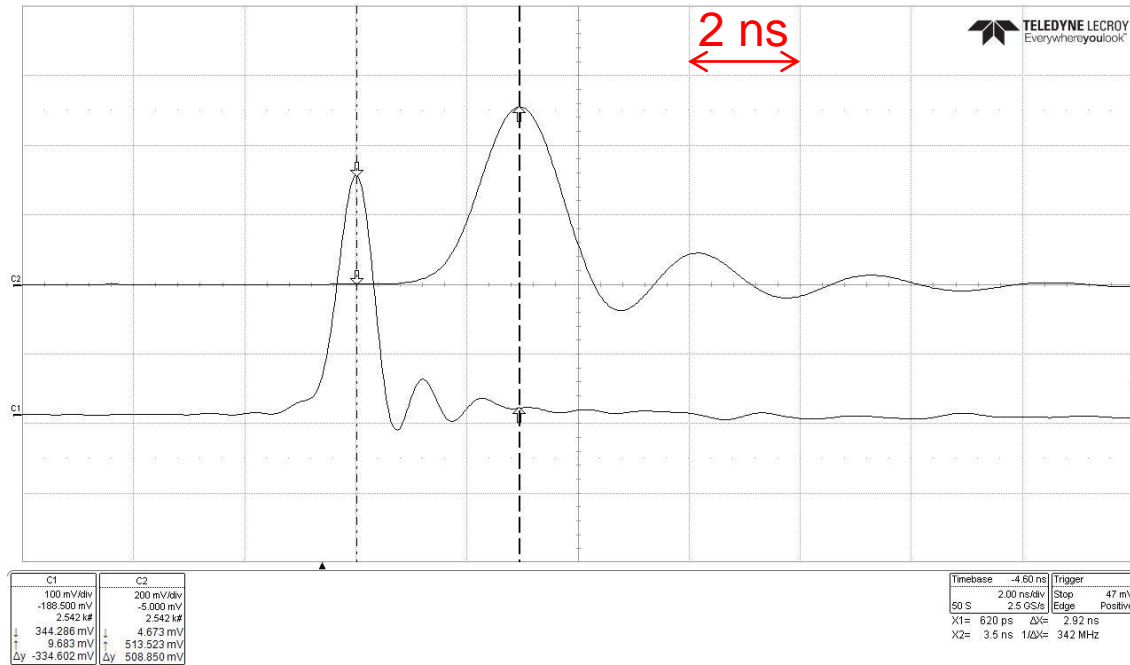
PROCESSING FOR ACQUISITION



Diode processor: Latency

Extra processing adds a lot of latency

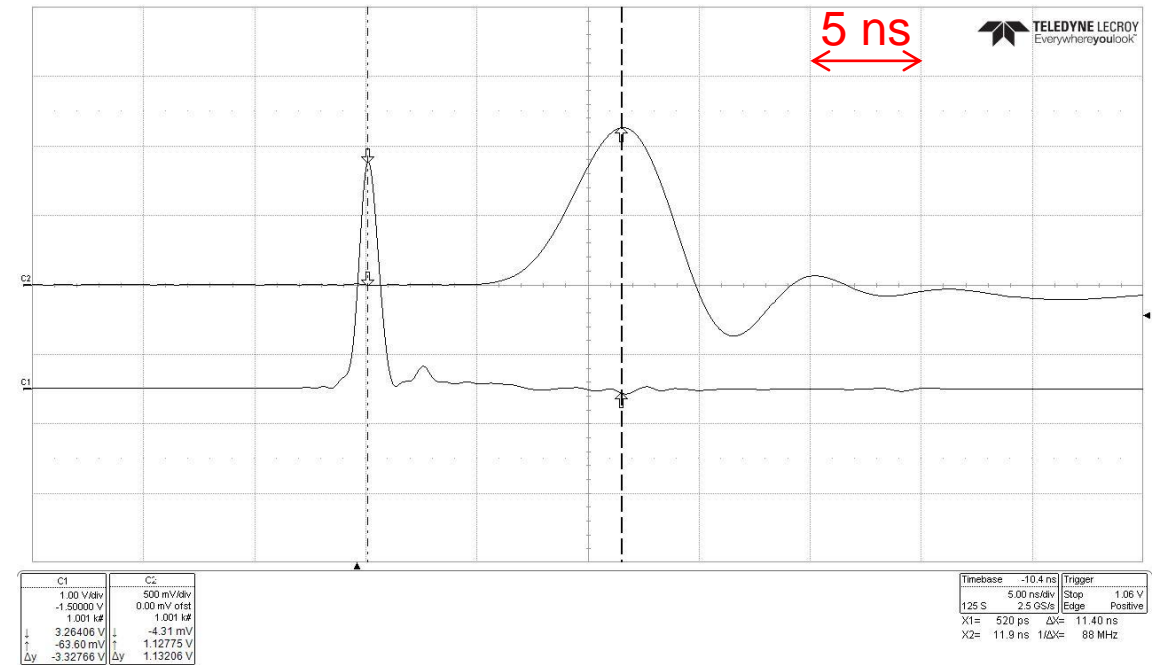
Pulse response after **diode processor**



Measured latency: **2.9 ns**

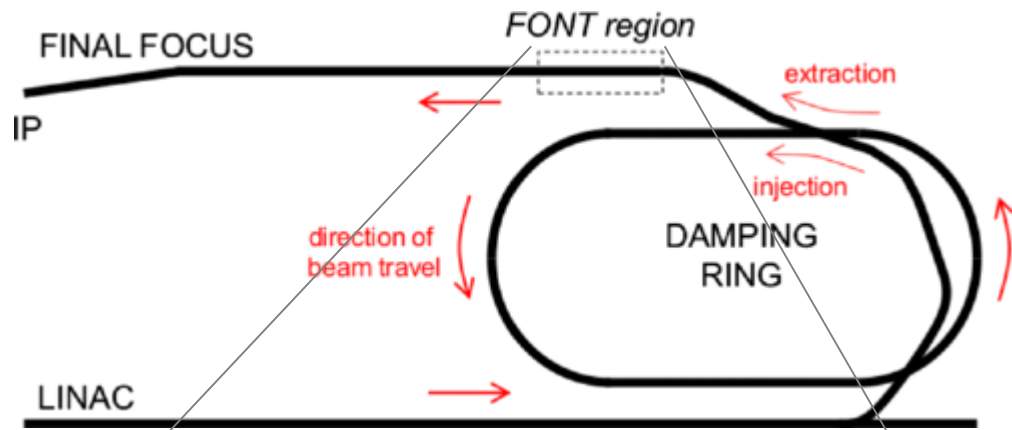
(would scale to ~1.0 ns for CLIC)

Pulse response after **supplemental stage**

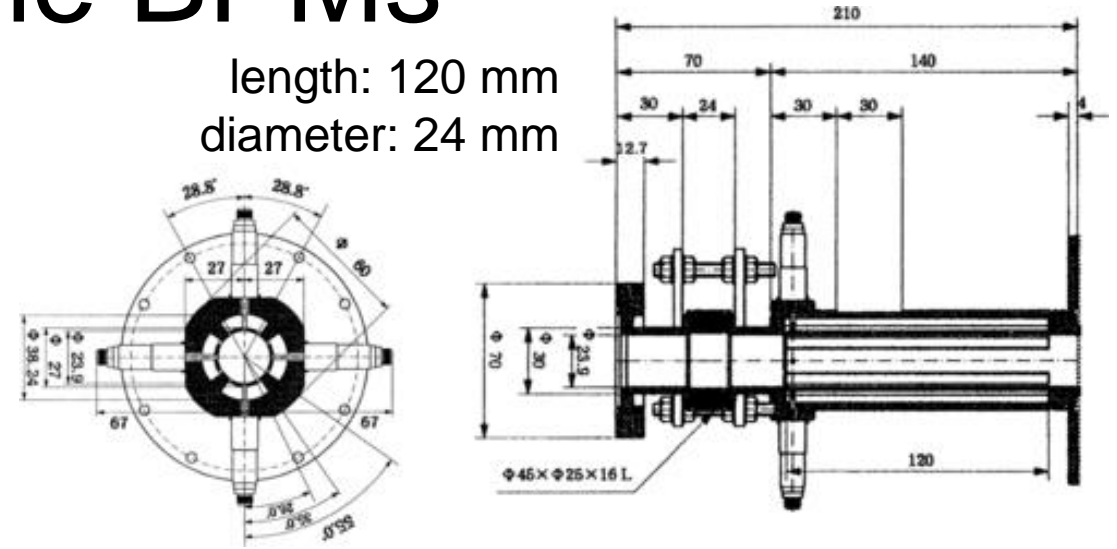


Measured latency: **10.4 ns**

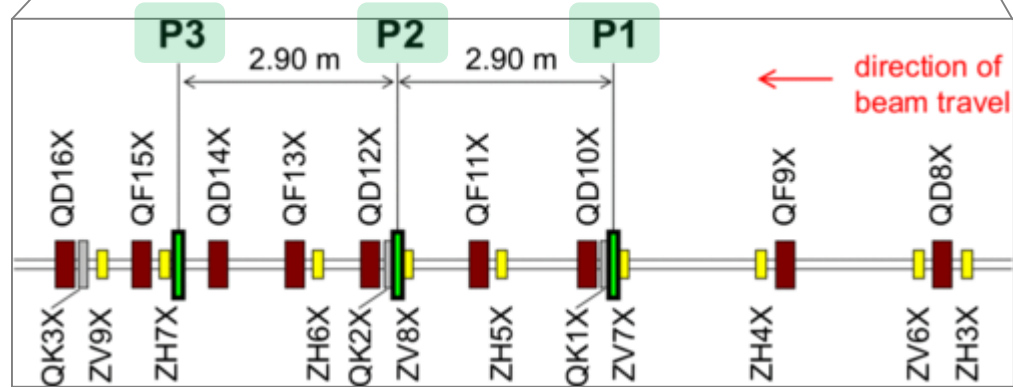
ATF: Stripline BPMs



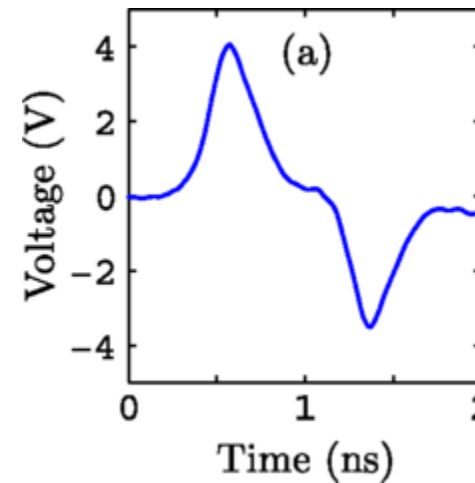
length: 120 mm
diameter: 24 mm



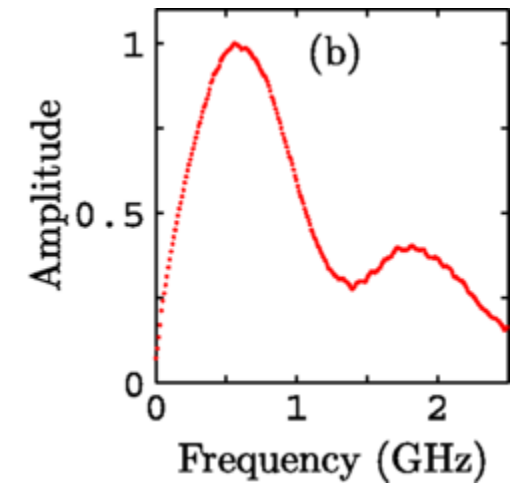
set of three stripline BPMs



Time domain



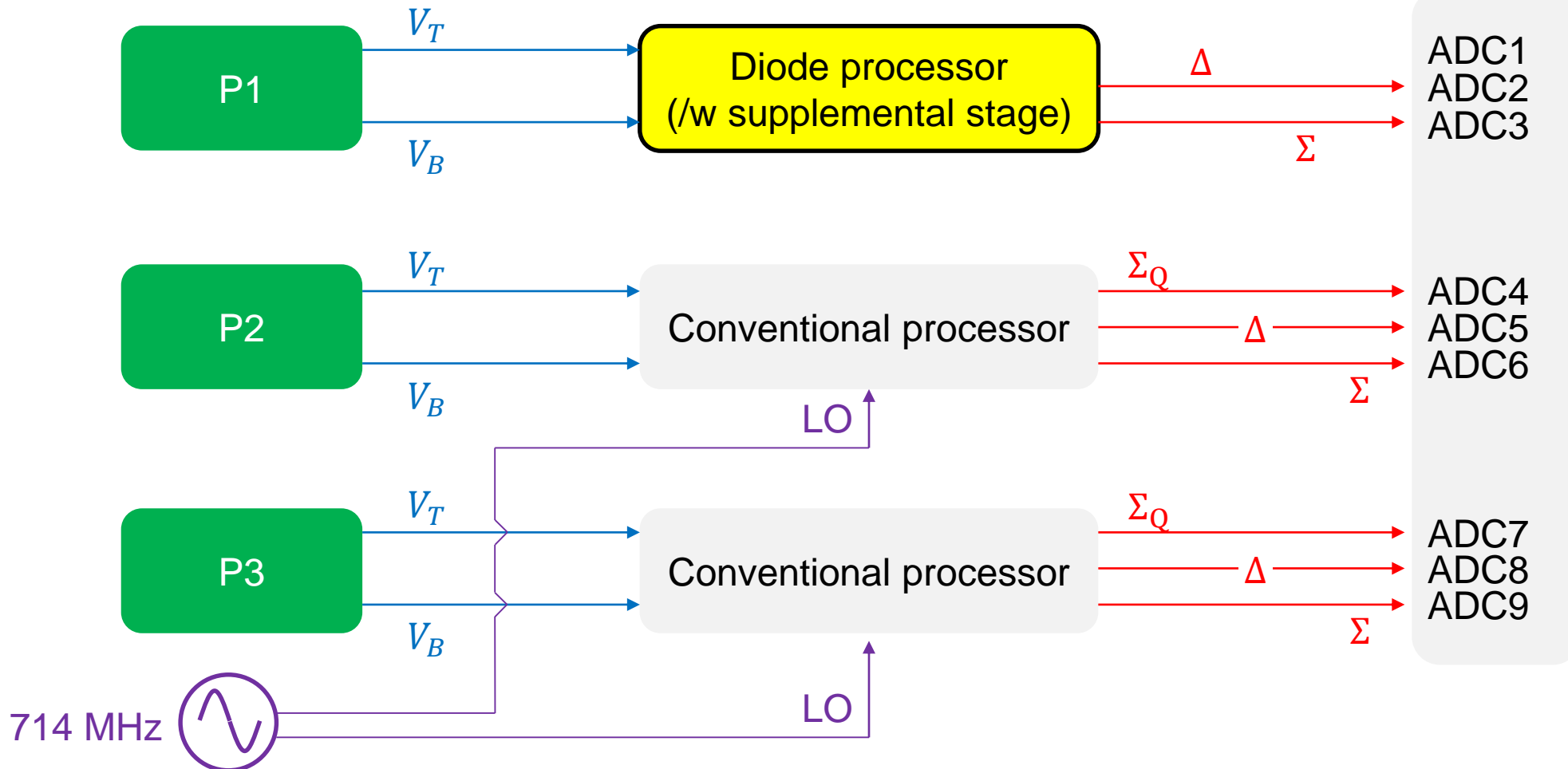
Frequency domain



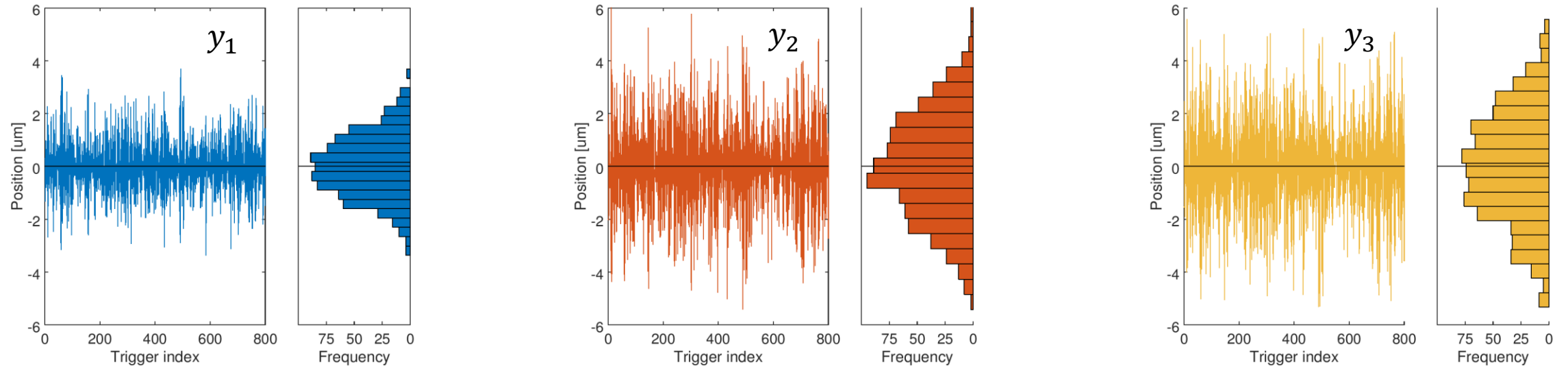
ATF: Acquisition

Stripline BPMs

FONT5 digital board



ATF: Results



- Define residual position at P1: $y_{res} = y_1 - (C_{12}y_2 + C_{13}y_3)$ (where C_{12} , C_{13} are geometric coefficients)
- Variance of residual given by weighted sum in quadrature of BPM resolutions: $\sigma_{res}^2 = \delta_1^2 + C_{12}^2\delta_2^2 + C_{13}^2\delta_3^2$
- Assume conventional processors have equal resolution ~ 200 nm* at relevant beam charge (0.65×10^{10})
- Estimated resolution of diode processor (with supplemental stage) is then ~ 325 nm

Conclusion

- Proof-of-concept **diode processor** designed for the CLIC IP feedback system
- Prototype tested on stripline BPMs at KEK ATF, but design scalable to CLIC requirements
- Latency of **2.9 ns** measured in lab (scaling to **1.0 ns** for CLIC design)
- Supplemental processor stage necessary at ATF to condition diode processor outputs for use with existing digitizer and results in an overall latency of **10.4 ns**
- Resolution of diode processor (with supplemental stage) estimated at **325 nm**